

The SCRIT Facility at RIKEN

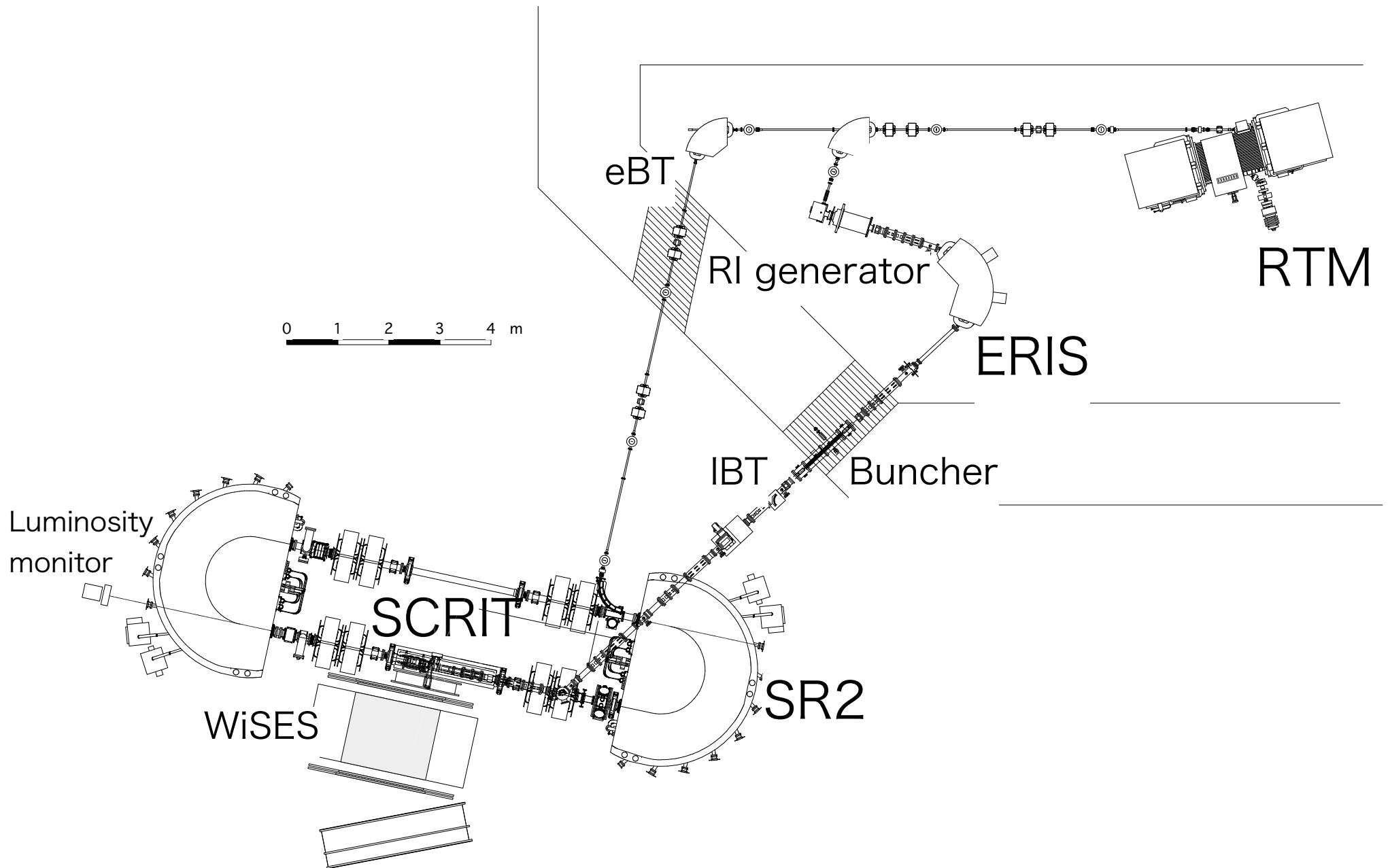
M. Wakasugi and SCRIT collaborations

Work shop on e-Ion collision at CEA Saclay
(25-27 Apr. 2016)

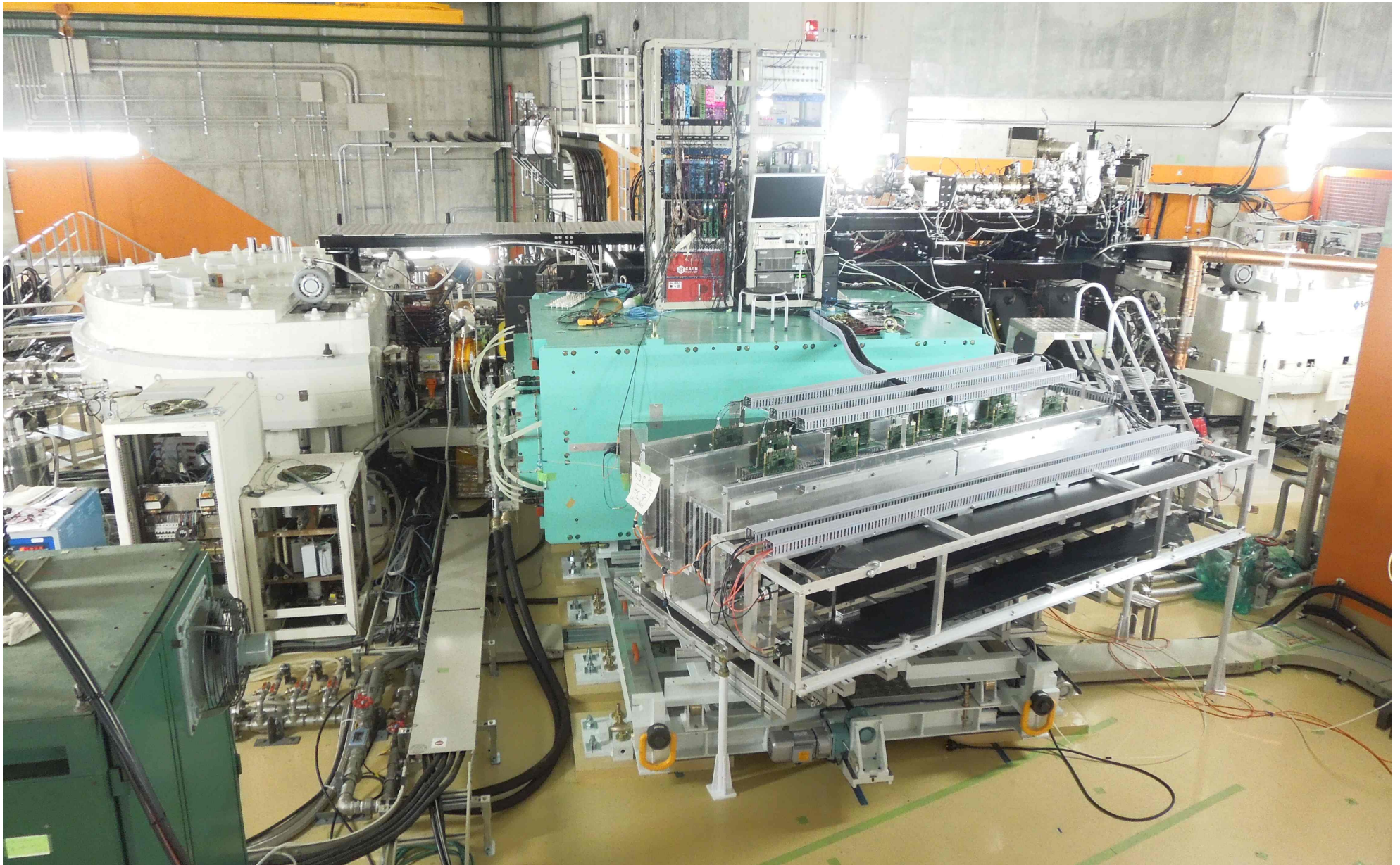
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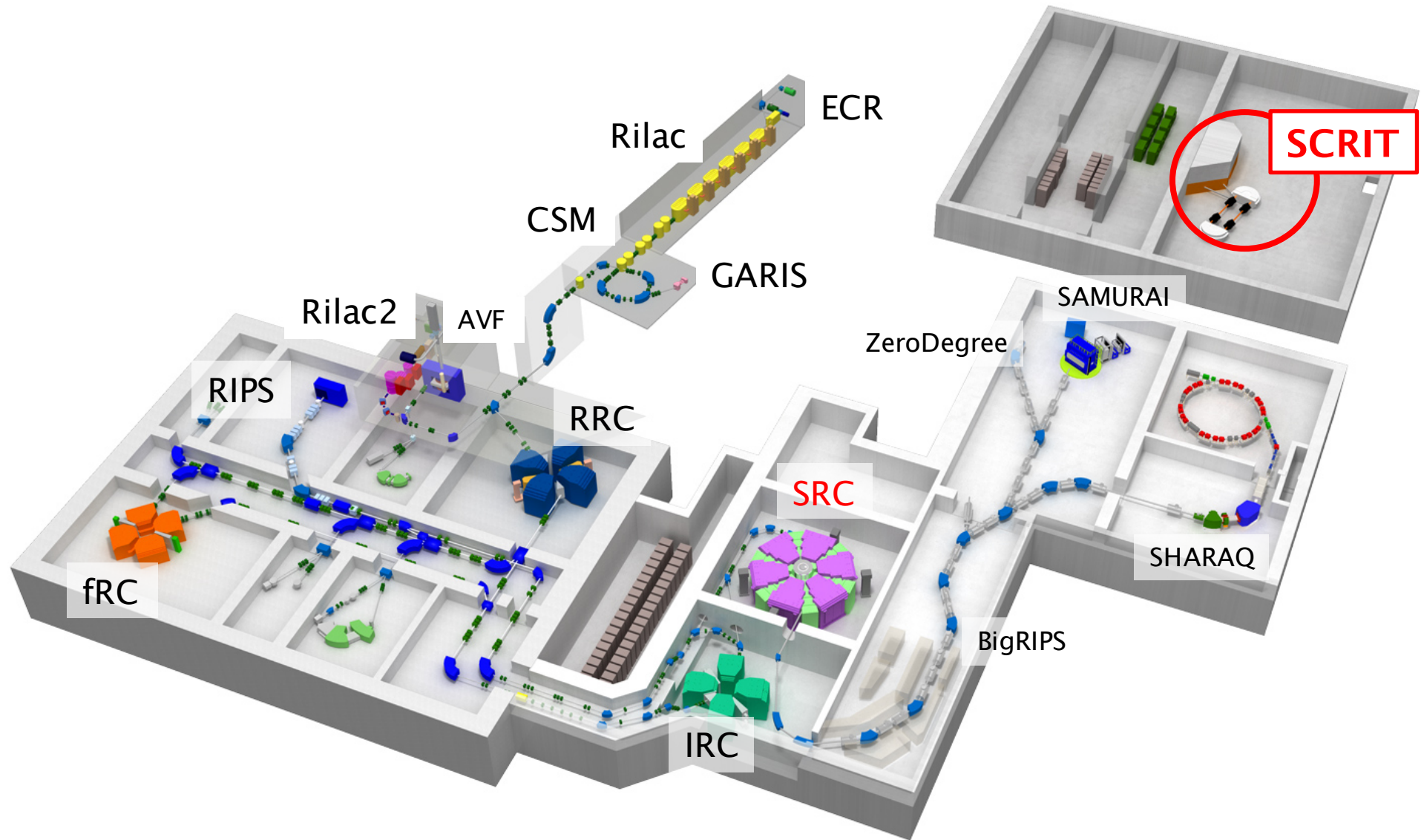
The SCRIT Electron Scattering Facility



The SCRIT Electron Scattering Facility



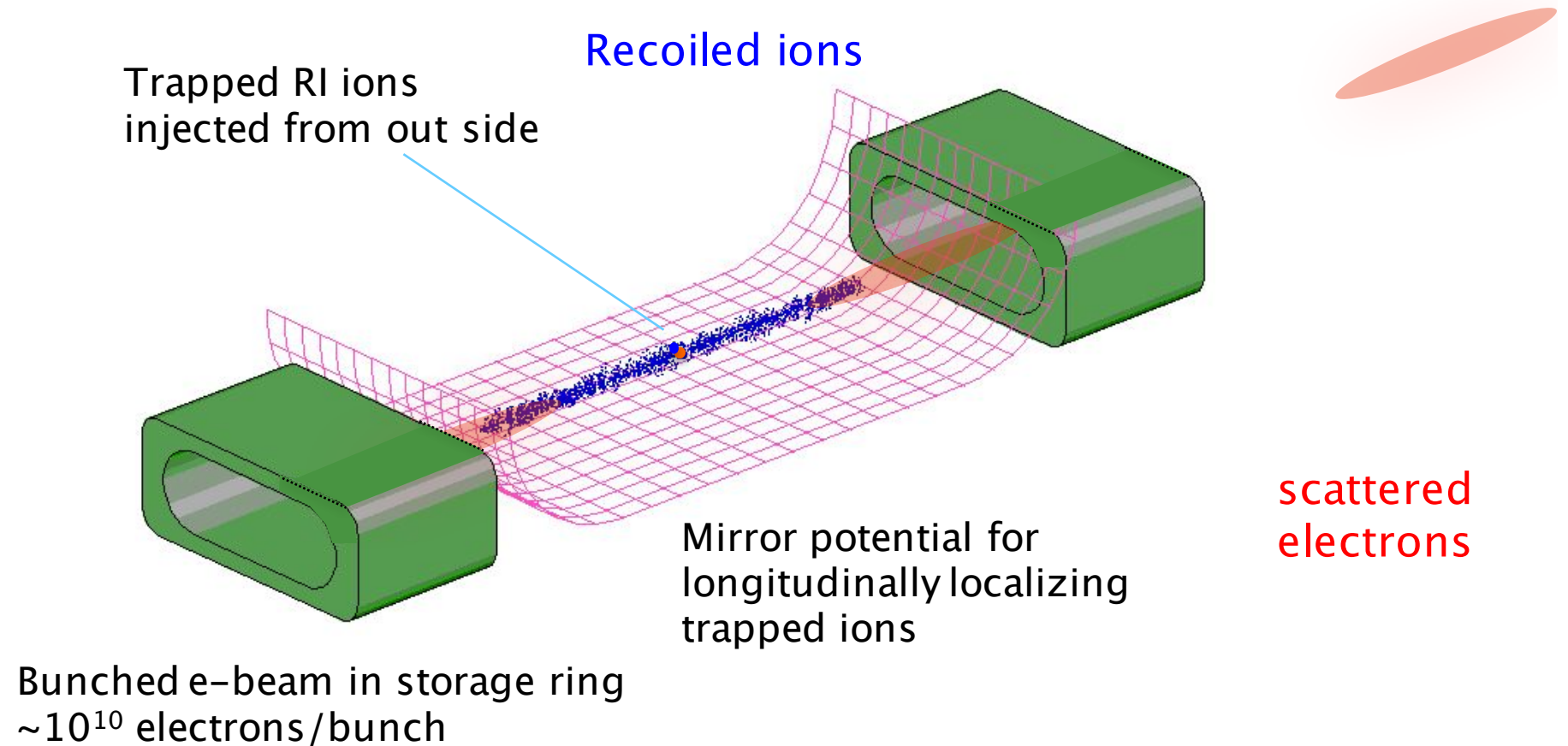
Location of the SCRIT Facility in the RIKEN RI Beam Factory



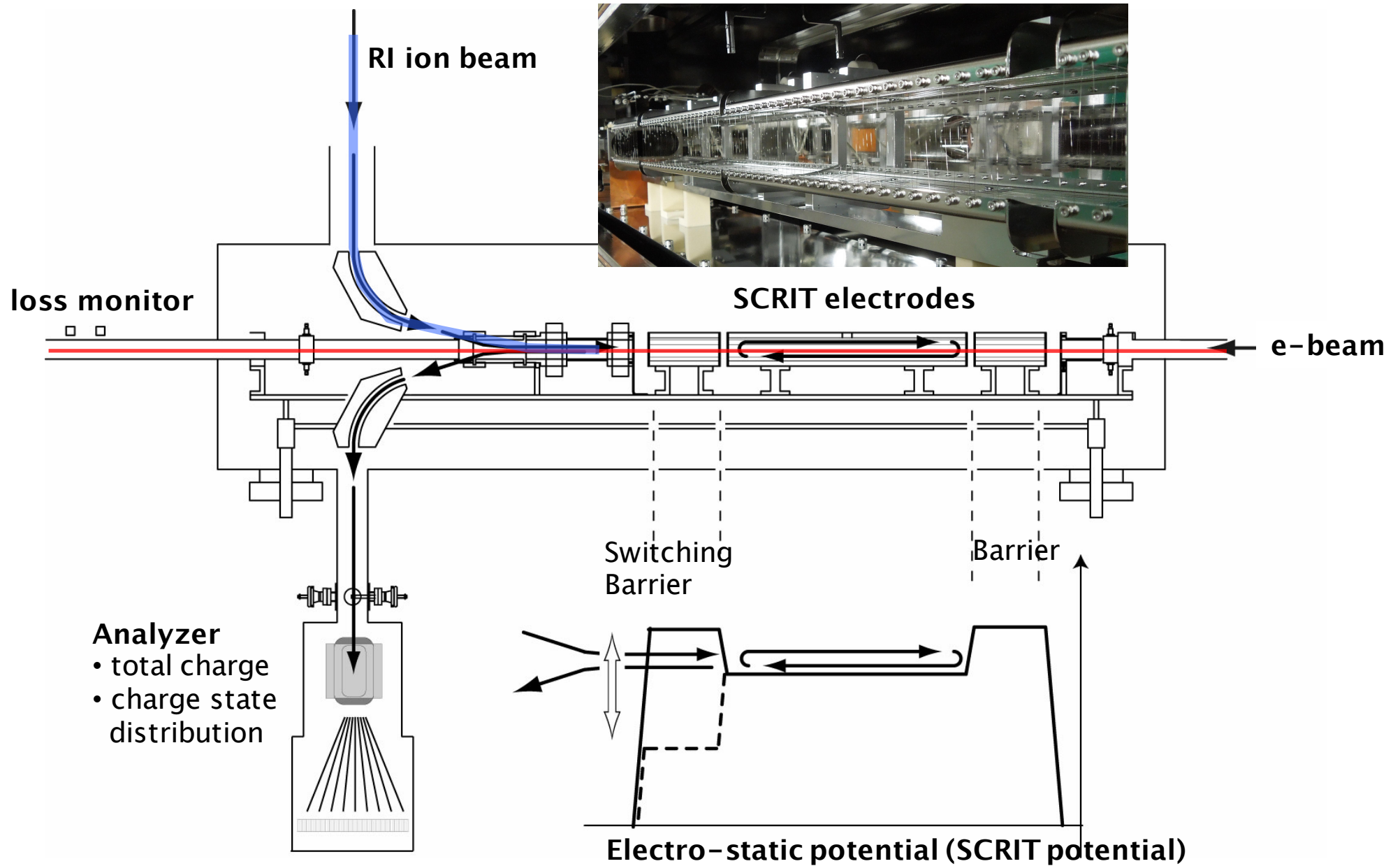
SCRIT (Self-Confining RI Ion Target)

SCRIT is internal-target-forming technique in an electron storage ring.

Target ions are confined in the beam orbit by periodic focusing force.

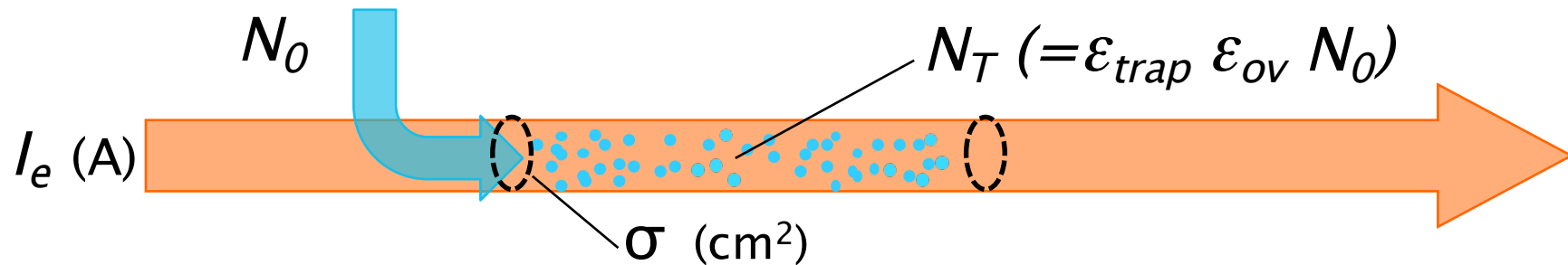


The SCRIT device



Luminosity and related properties of e-beam and target ion trapping

Achievable luminosity



$$L \sim \frac{I_e/e \ N_T}{\sigma} \ /(\text{cm}^2\text{s})$$

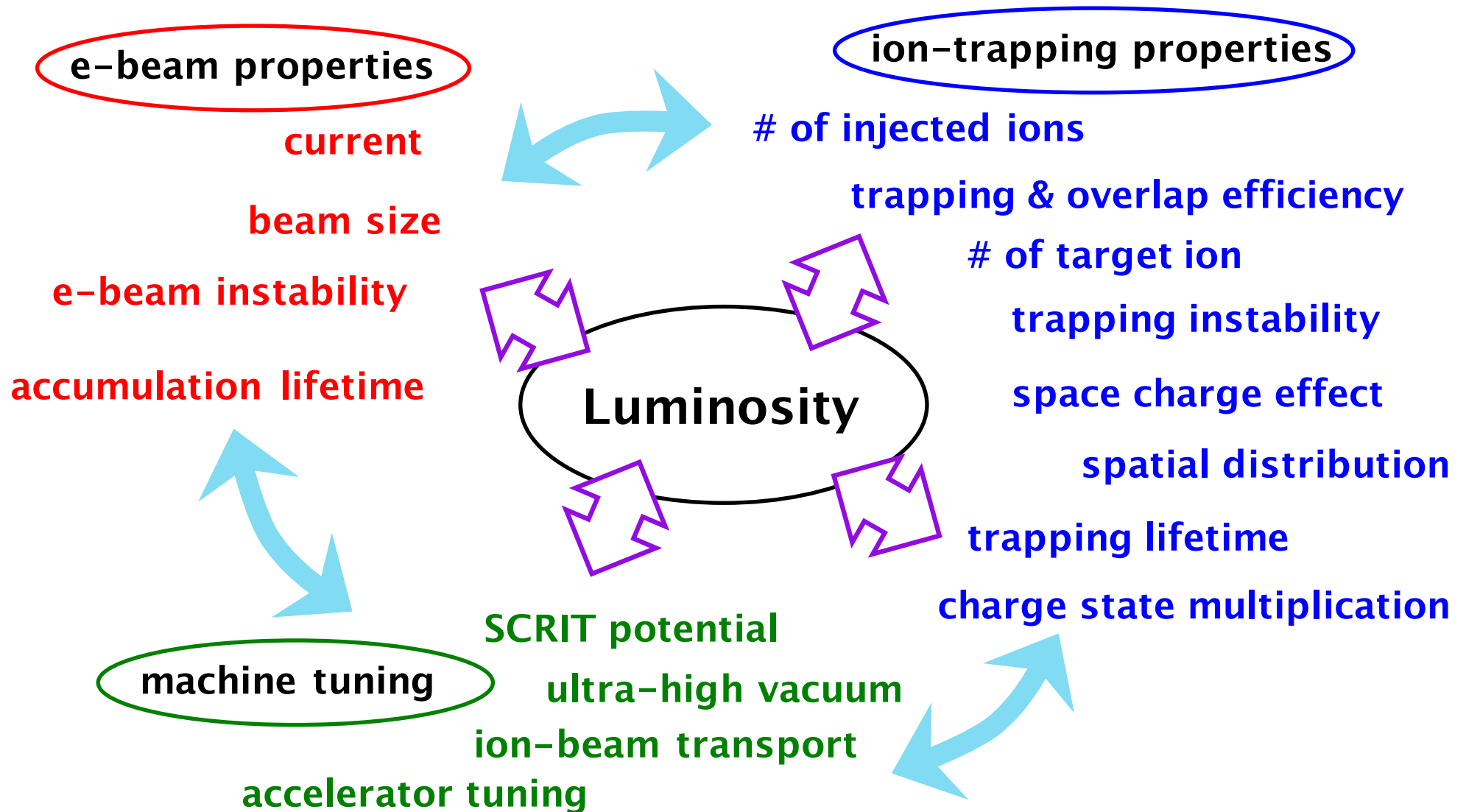
Current performance (typical)

at $I_e \sim 220\text{mA}$
 $\sigma \sim 3.5\text{mm}^2$ $\Rightarrow L \sim 10^{27} \ /(\text{cm}^2\text{s})$
 $N_0 \sim 2 \times 10^8$

Number of target ions $N_T \sim 2.6 \times 10^7$

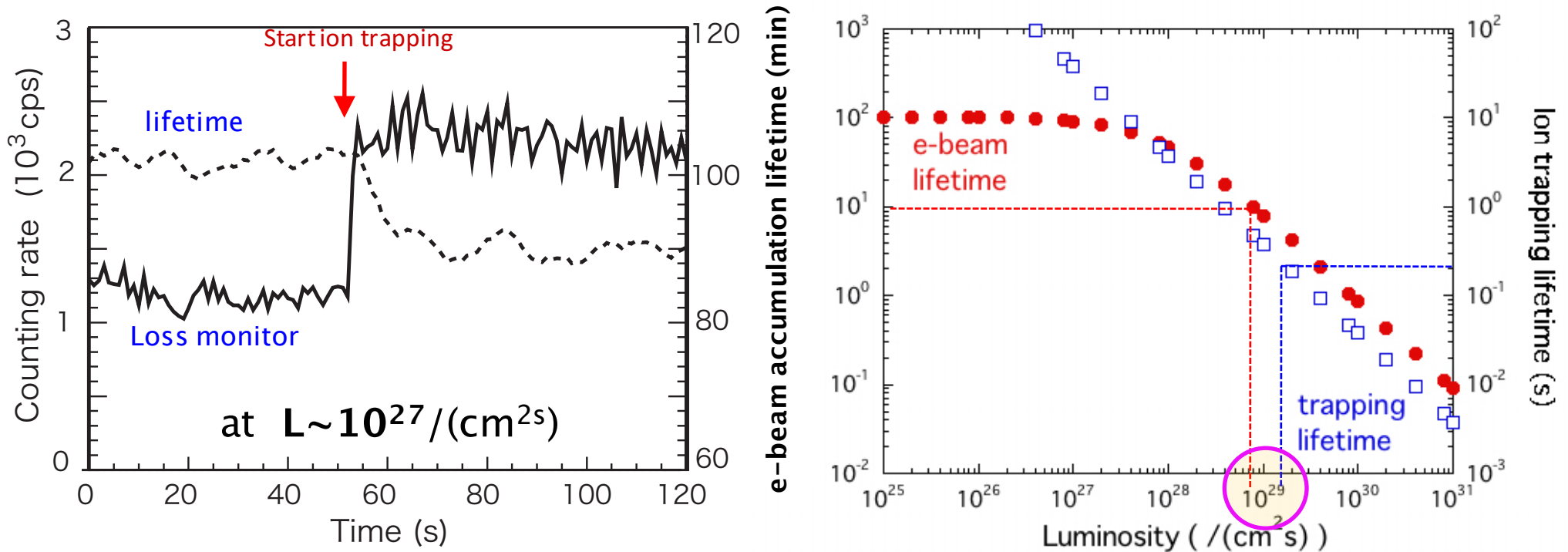
Total efficiency $\epsilon_{trap} \epsilon_{ov} = N_T/N_0 \sim 13 \%$

luminosity is strongly related to e-beam & ion-trapping properties



Luminosity results from achieving a practical balance between these properties

Luminosity limit in the SCRIT system



- **Scattered electrons** with the angle over **3 mrad** are lost.
- **Recoiled ions** with kinetic energy over **10eV** are lost.

Assuming:

e-beam lifetime limit = **10 min.**

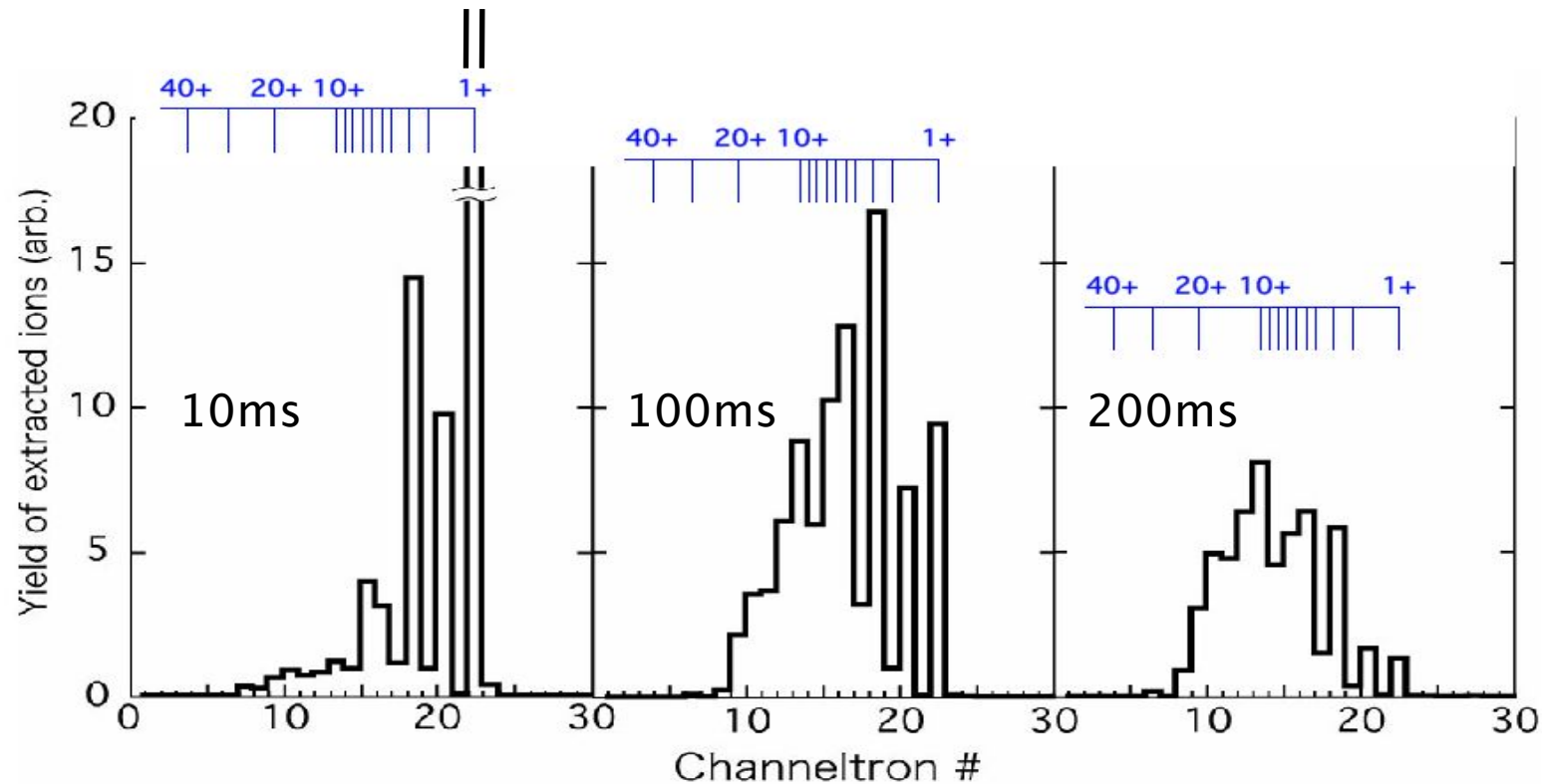
ion trapping lifetime limit = **200 ms**

Upper limit of luminosity:

⇒ **$\sim 10^{29} / (\text{cm}^2 \text{s})$**

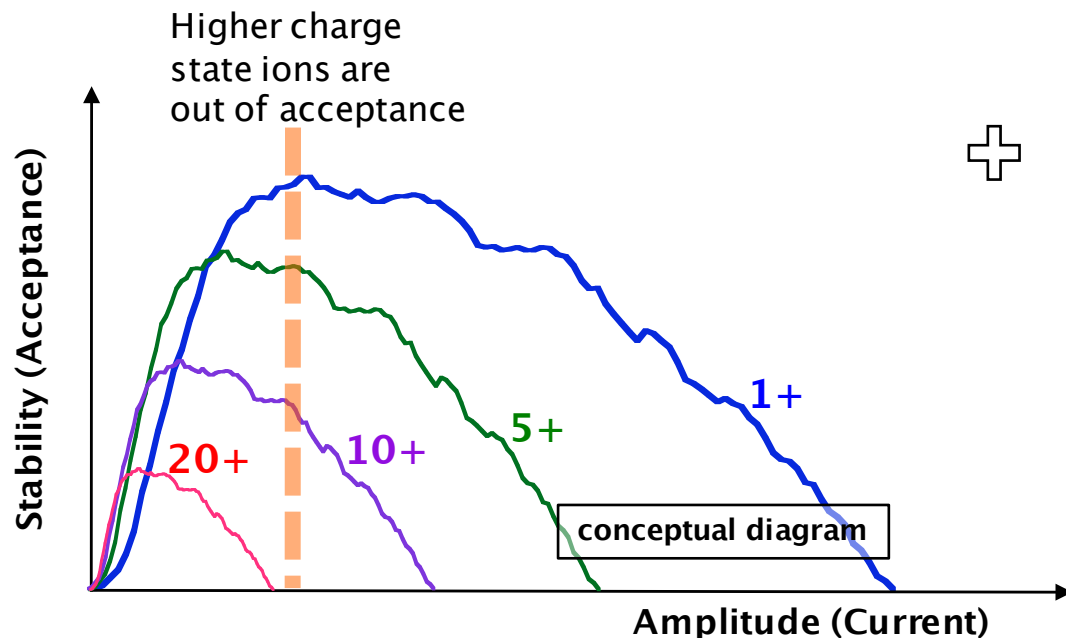
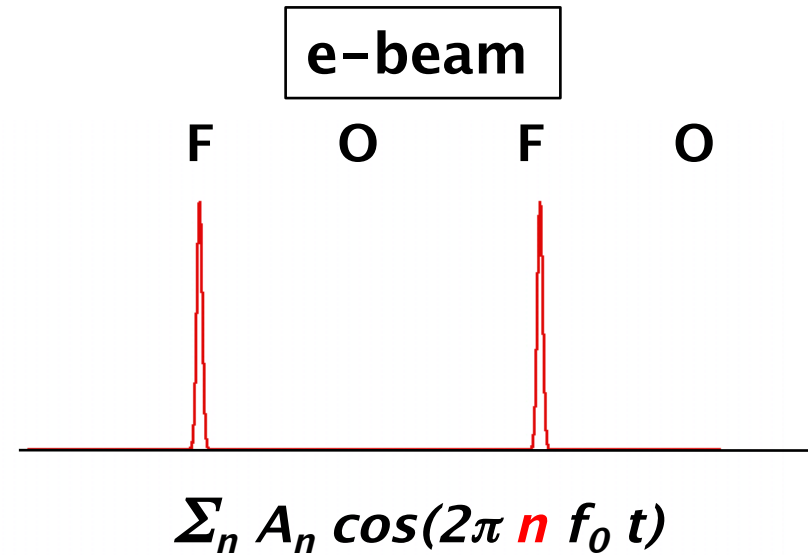
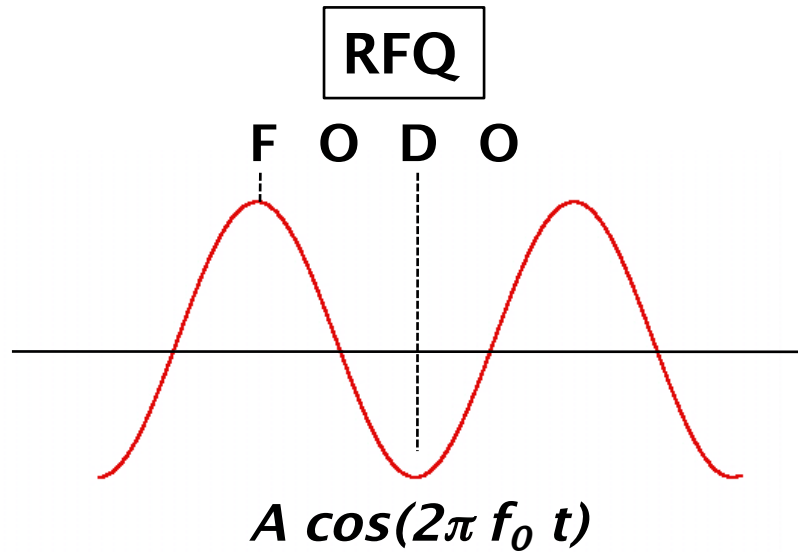
Charge state multiplication in SCRIT

(Higher luminosity induces faster charge-state multiplication)



- Maximum charge state is $\sim 20+$, and higher charge states ($>20+$) do not exist in the SCRIT.
 - Dropout of higher charge state ions
- Rapid increase of total charge (target ions + residual gas ions)
 - Space charge effect (Neutralization limit : $f \times 2 \times 10^9$ ($f: 0.2 \sim 0.5$) at 200mA)

SCRIT ion trapping is in principal the same with RFQ



+

Non-periodic term :

$$\sum_n \underline{A_n(x,t)} \cos(2\pi n f_0 t) + \underline{C(x,t)}$$

due to

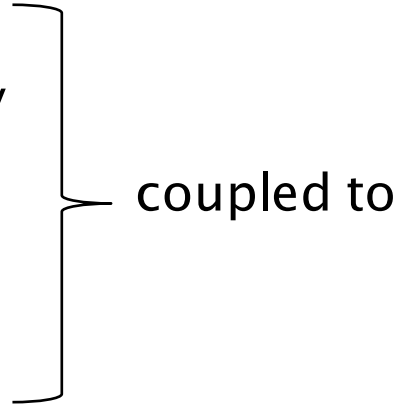
- e-beam instability
- space charge effect
- etc.

Non-periodic term induces shorter trapping lifetime.

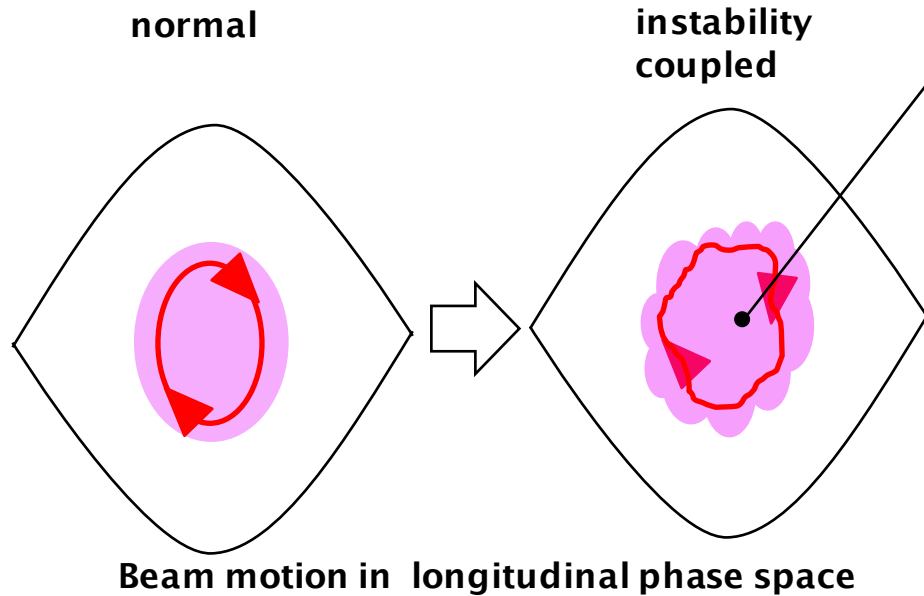
Electron beam instability

(We should take it seriously)

Microwave instability
Coupled bunch instability
HOM excited in cavity
Intra-beam scattering
Tune shift and spread
etc.



Synchrotron oscillation
Betatron oscillation

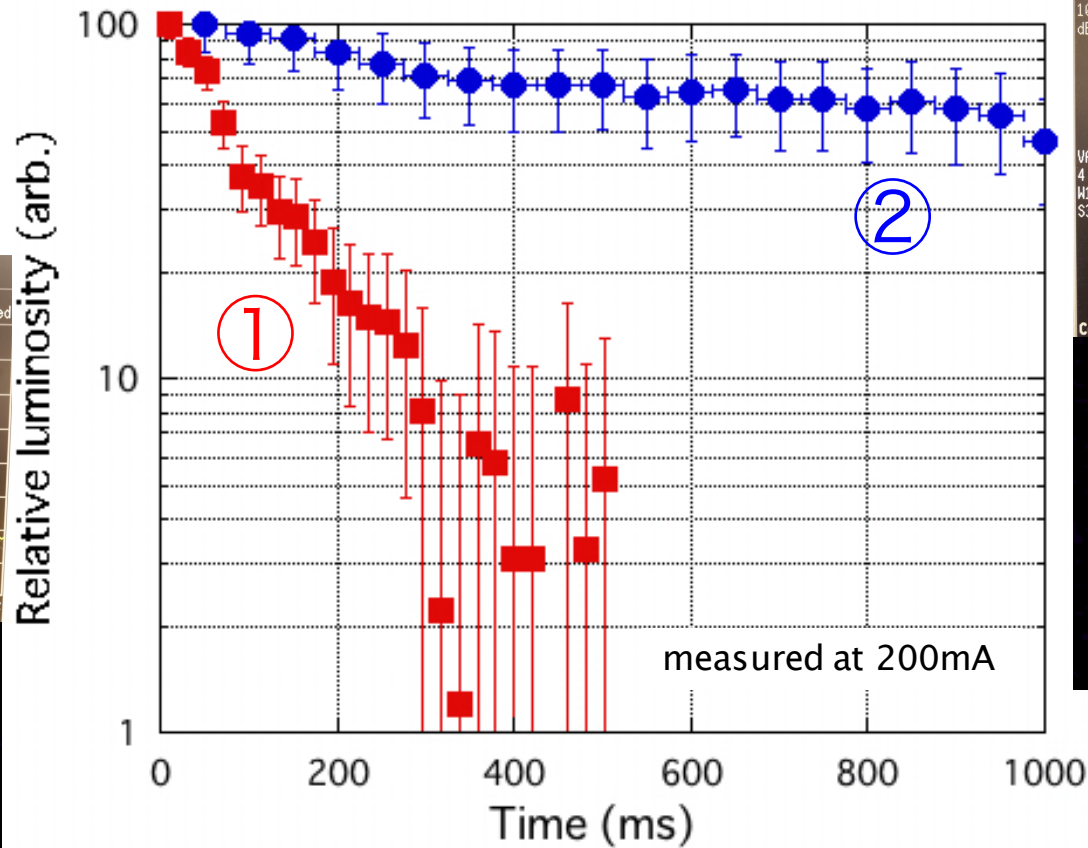
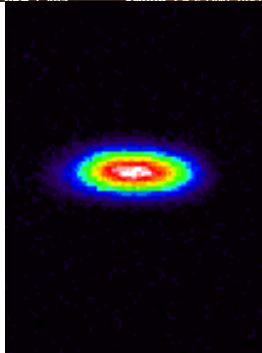
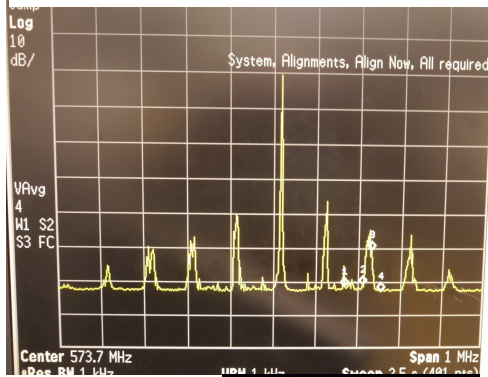


Induced multi-pole coherent motion

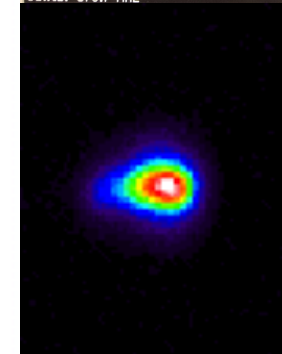
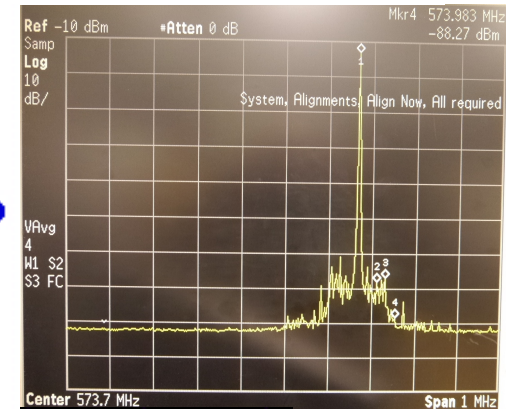
- Dipole → Beam axis oscillation at dispersive section
Periodicity oscillation
- Quadrupole → Beam size oscillation at dispersive section
Bunch length oscillation
- Octapole →
-

Trapping lifetime reduction due to e-beam instability

① coherent synchrotron oscillation



② synchrotron oscill. suppressed beam

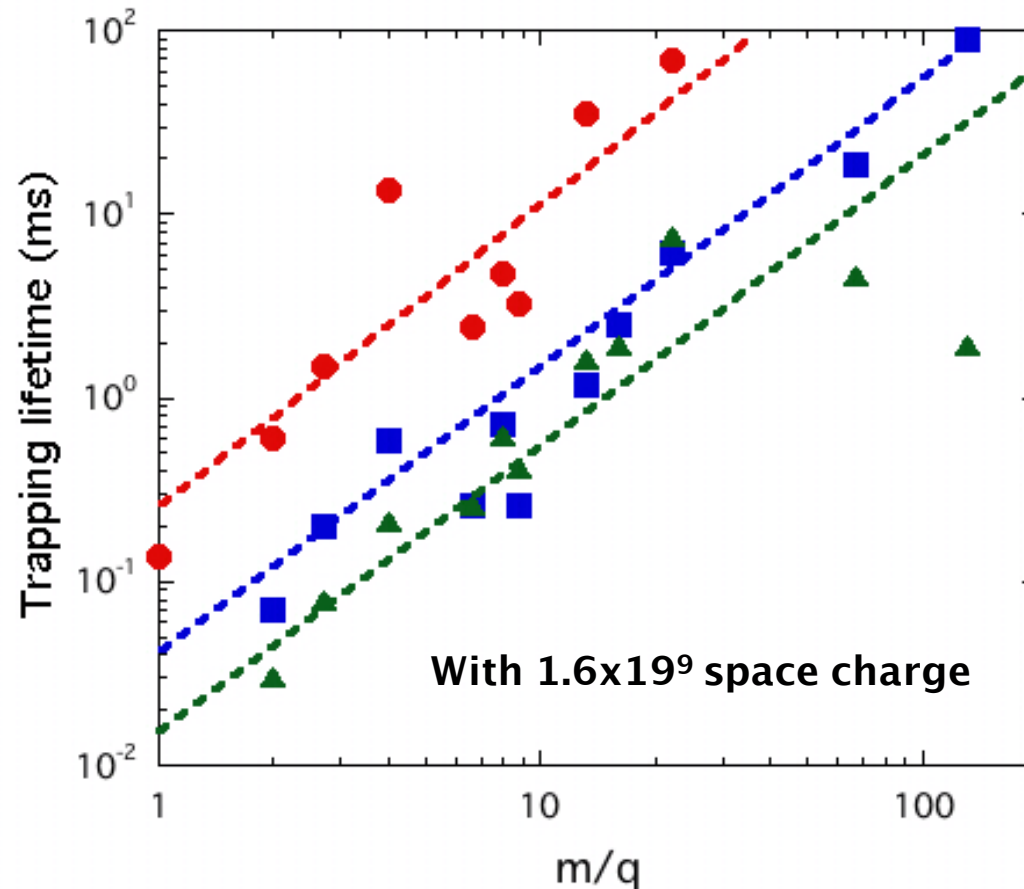


The e-beam instability dominates the ion trapping properties

Influence of e-beam instability and space charge

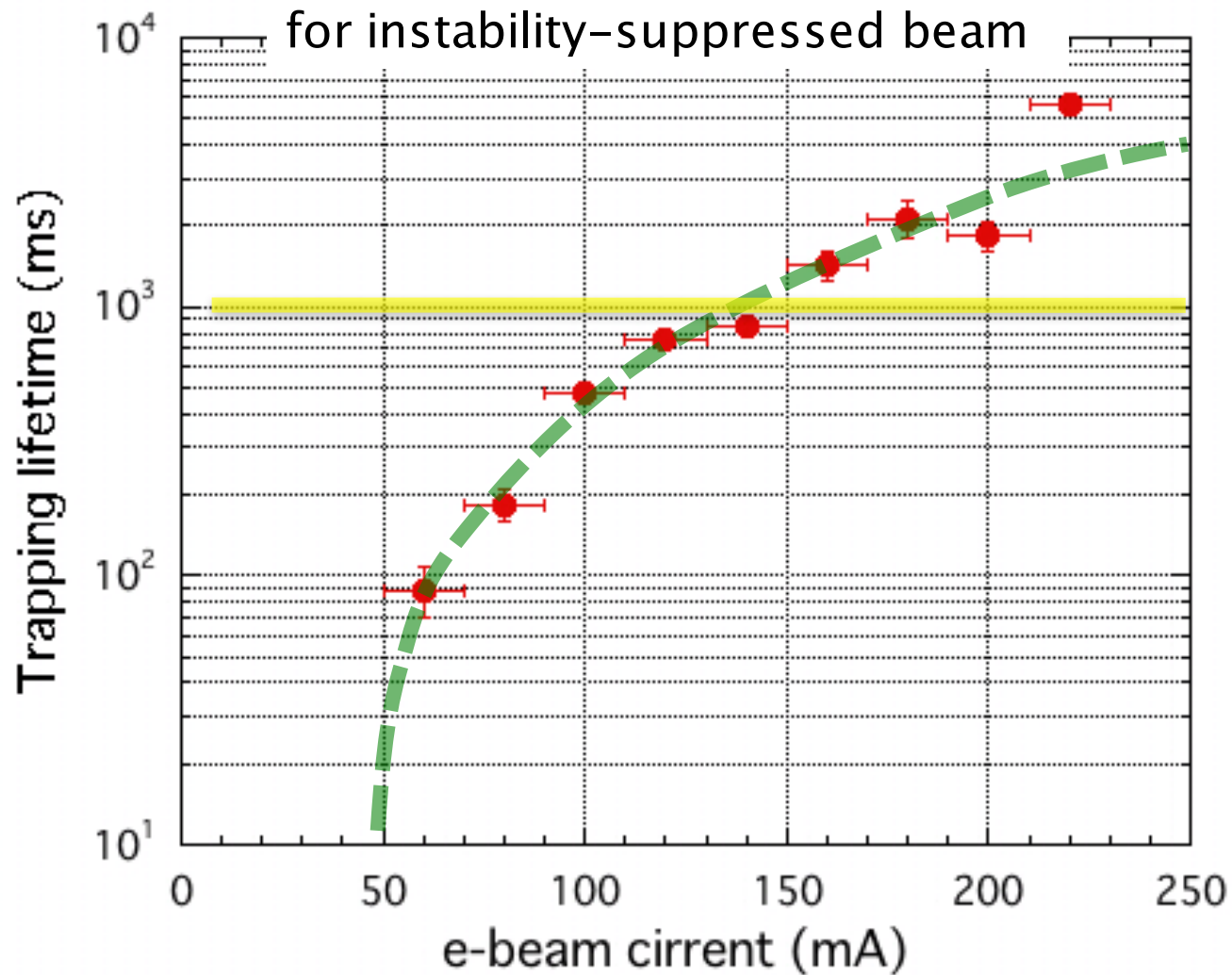
Ion trapping lifetime with coherent synchrotron oscillation
(simulation)

Synchrotron oscillation
amplitude in real space
0.1 mm
0.5 mm
1.0 mm



e-beam instability extremely reduces the trapping lifetime especially for highly charged ions.
Space charge enhances the trapping instability

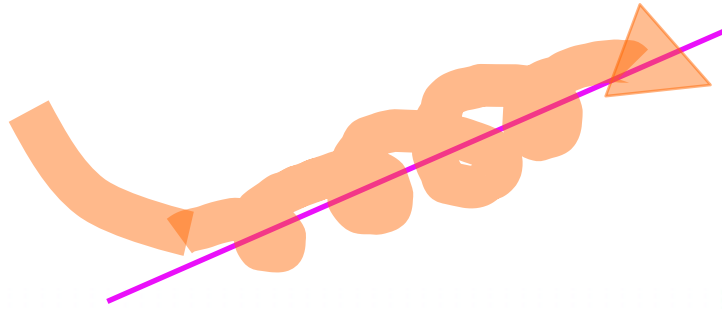
Current dependence of trapping lifetime



Necessary lifetime is
~1s for practical use

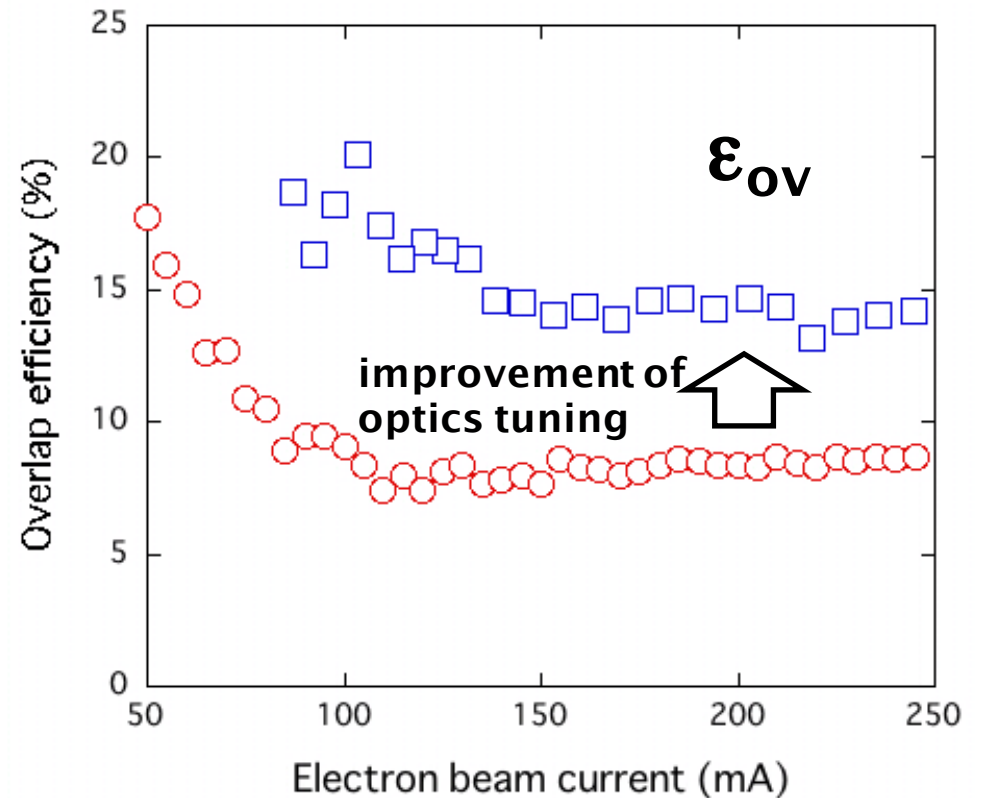
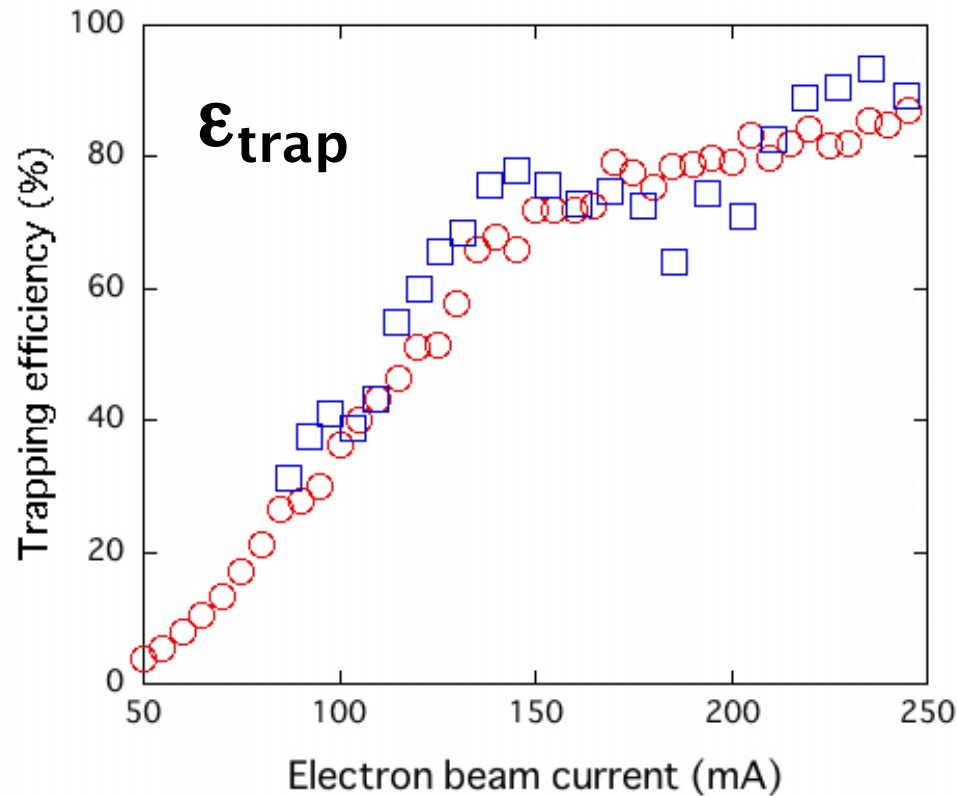
Prerequisite for e-beam
 $I_e > 150mA$
without instability

Trapping efficiency ϵ_{trap} and overlap efficiency ϵ_{ov}



$$N_T = \epsilon_{\text{trap}} \epsilon_{\text{ov}} N_0$$

At merging section, ion beam may **wrap** around electron beam axis due to **strong focusing force**.

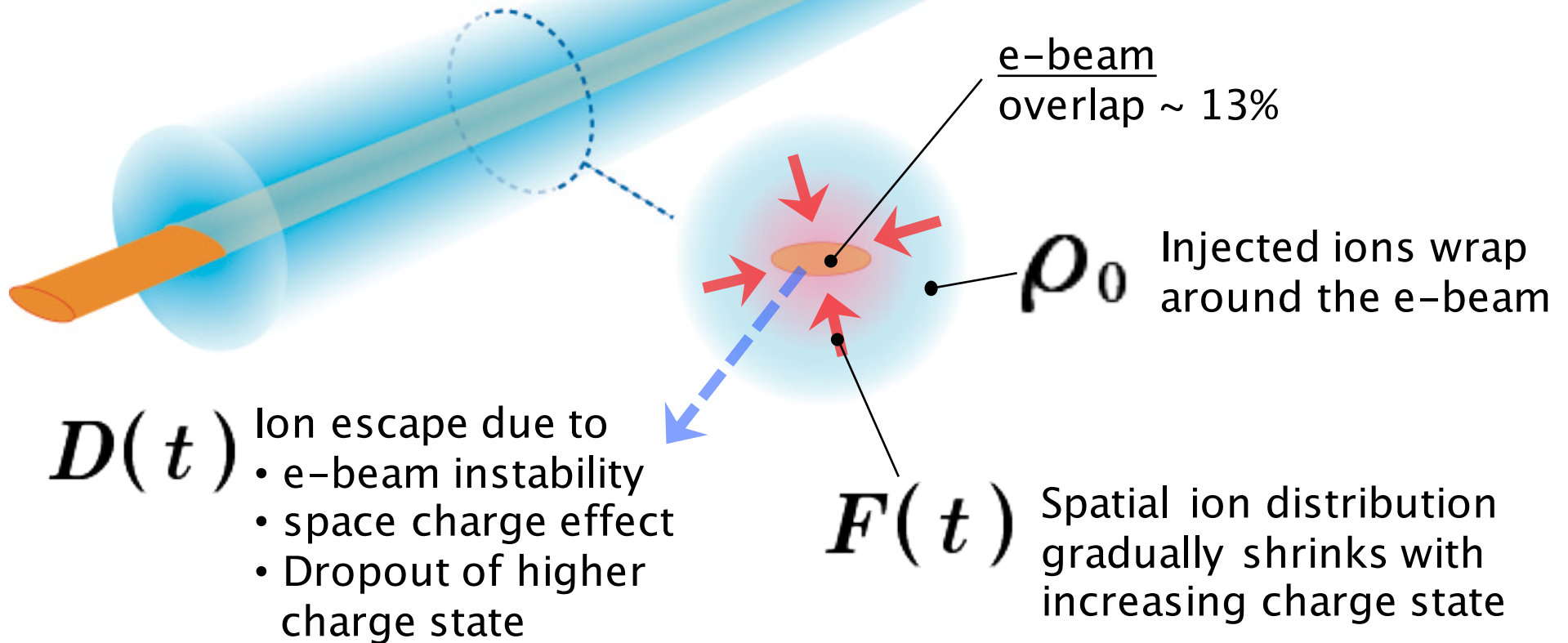
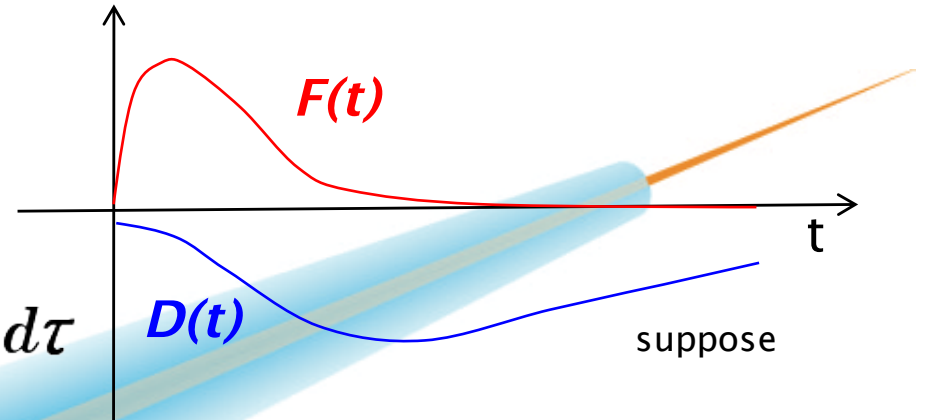


larger ϵ_{ov} \rightarrow higher luminosity \rightarrow shorter trapping lifetime

Ion trapping imagined from our measurements

$$\frac{d\rho_T(t)}{dt} = F(t) + D(t)$$

$$\rho_T(t) = \rho_0 + \int_0^t [F(\tau) + D(\tau)] d\tau$$



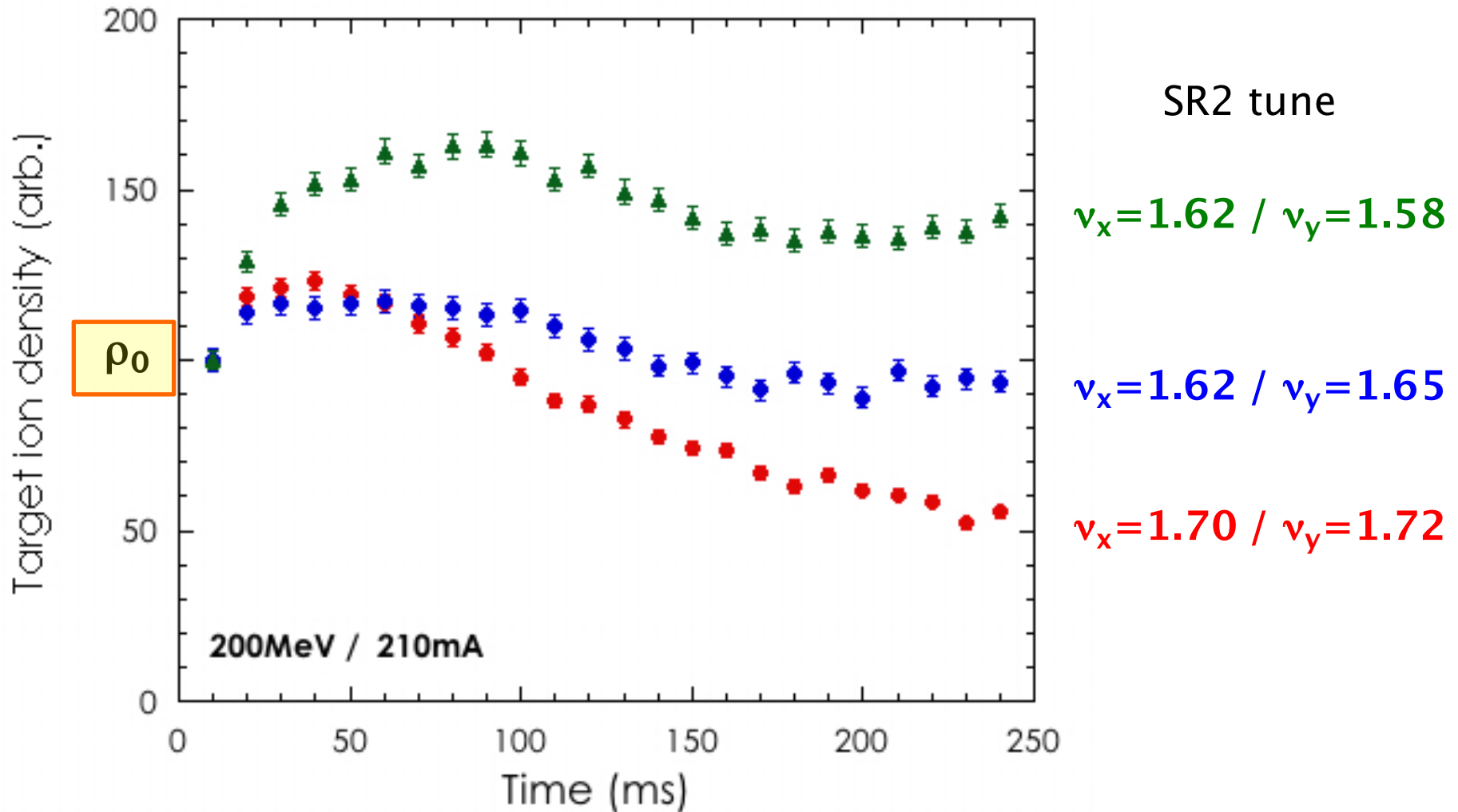
$D(t)$ Ion escape due to

- e-beam instability
- space charge effect
- Dropout of higher charge state

$F(t)$ Spatial ion distribution gradually shrinks with increasing charge state

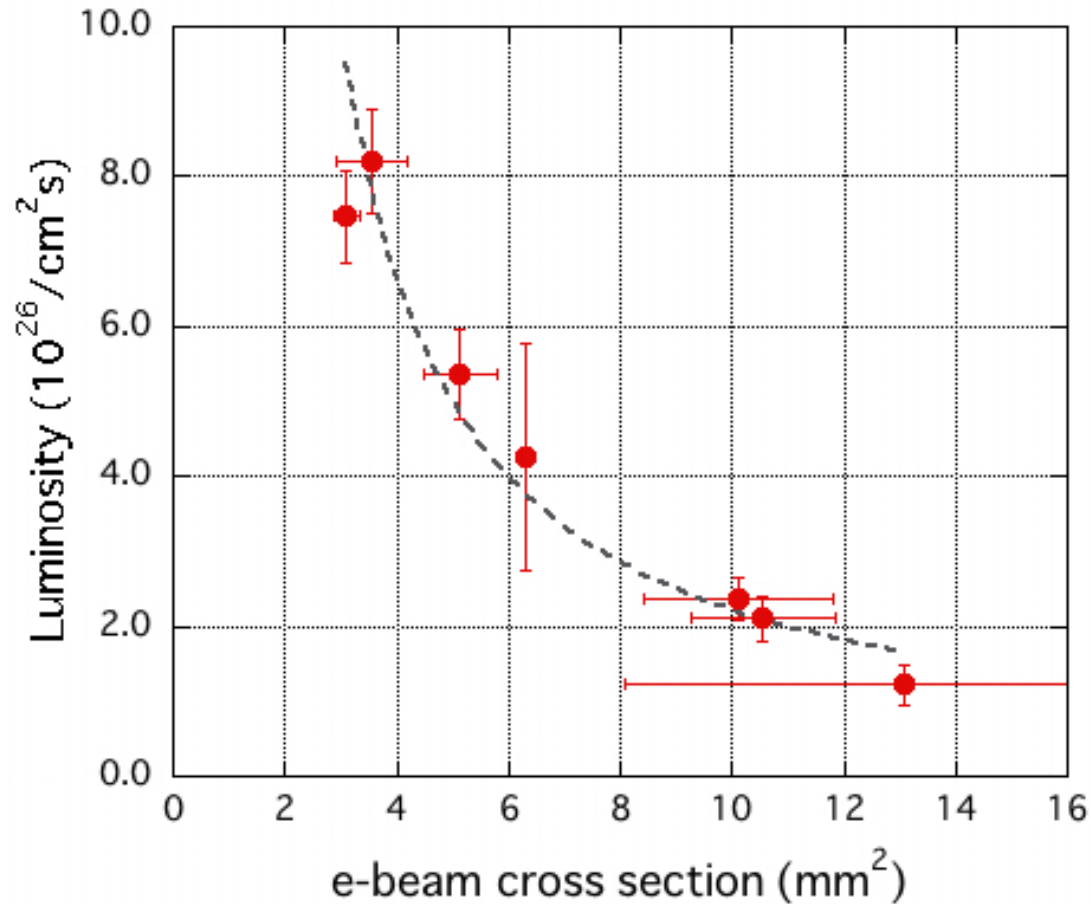
Time evolution of $\rho_t(t)$ ($\propto L$) in trap duration

There is a possibility to control $F(t)$ and $D(t)$ functions by adjusting e-beam parameters.



Luminosity depending on e-beam size

at the beginning of trap (proportional to ρ_0)



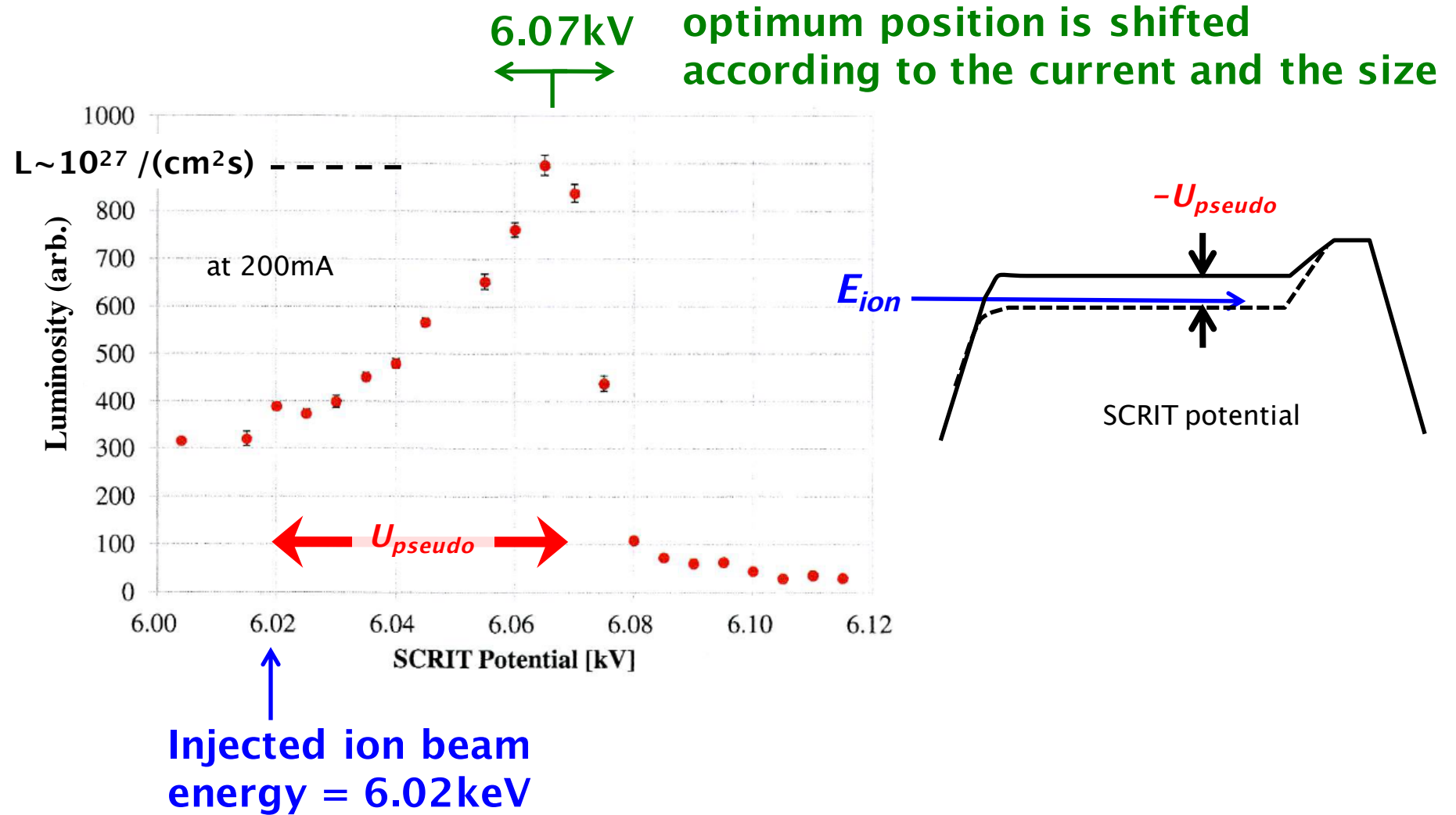
Luminosity is expressed by a linear fractional function of the beam cross section.

$$L \propto \frac{1}{a}$$

$$N_t \approx \text{constant}$$

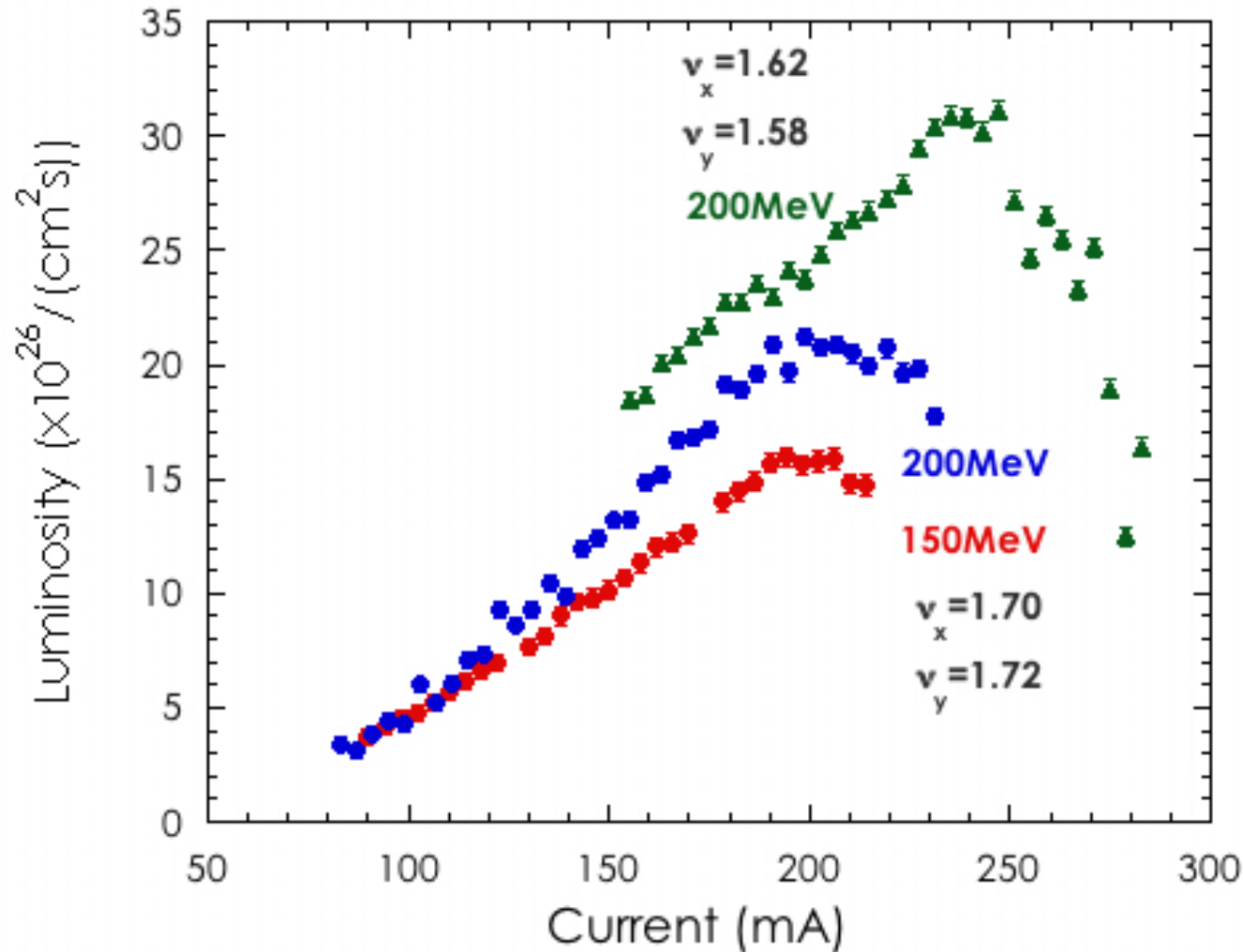
$$\rho_0 \propto \frac{1}{a}$$

Luminosity depending on the SCRIT electrostatic potential



Ion energy should be thermalized in the SCRIT

Achieved luminosity as a function of current



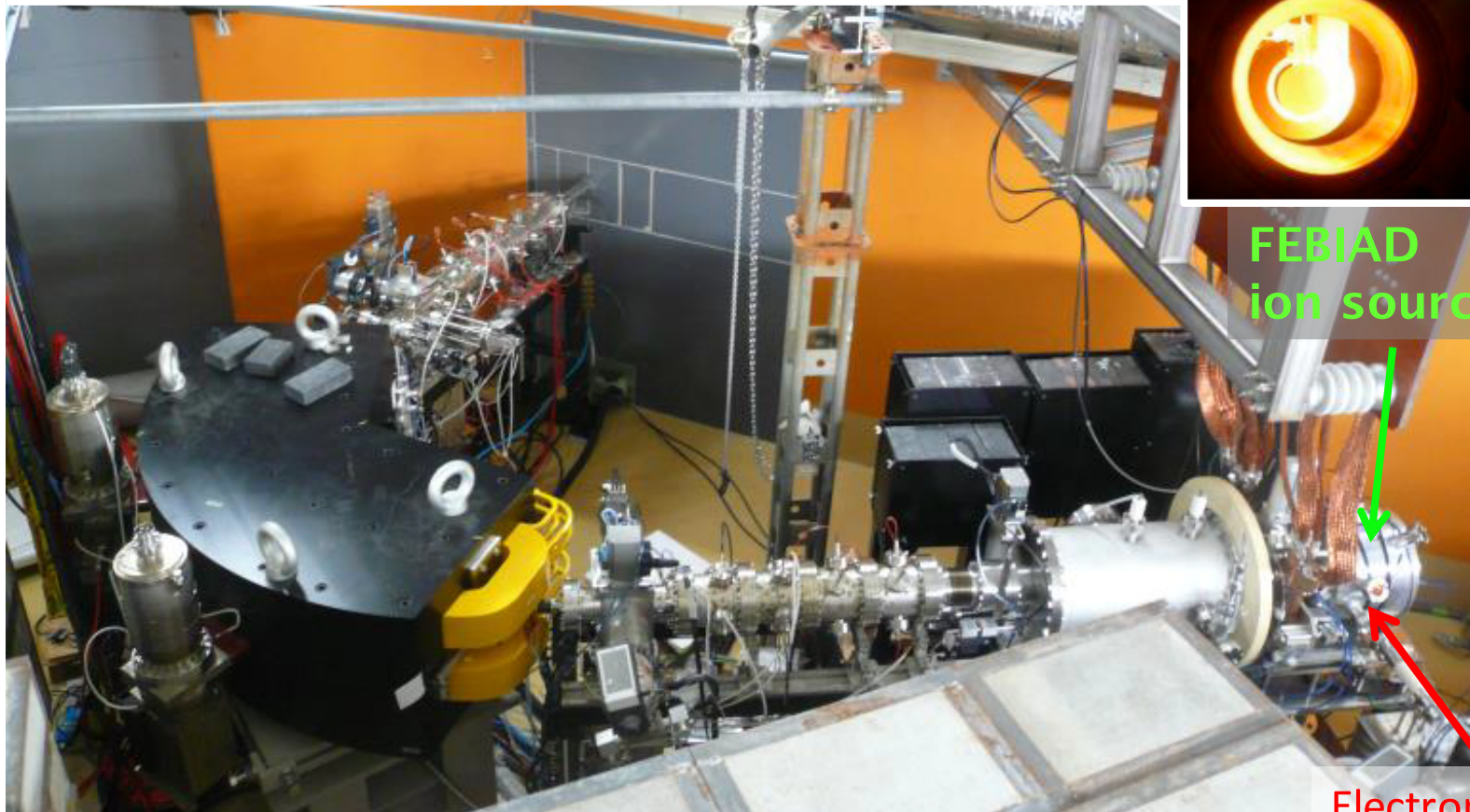
- Maximum luminosity was $3 \times 10^{27} / (\text{cm}^2 \text{s})$
- Number of injected ions was 3×10^8 .
- Trapping time was 240ms.
- Instability was happen in large current region.
- Luminosity for 200MeV is larger than that for 150MeV, because of smaller beam size.

Preparation of target RI ions

ERIS (Electron-beam-driven RI separator for SCRIT)

Performances

mass resolution $M/\Delta M$ 1660
overall efficiency 21 %
(record values for stable Xe isotopes)



UCx

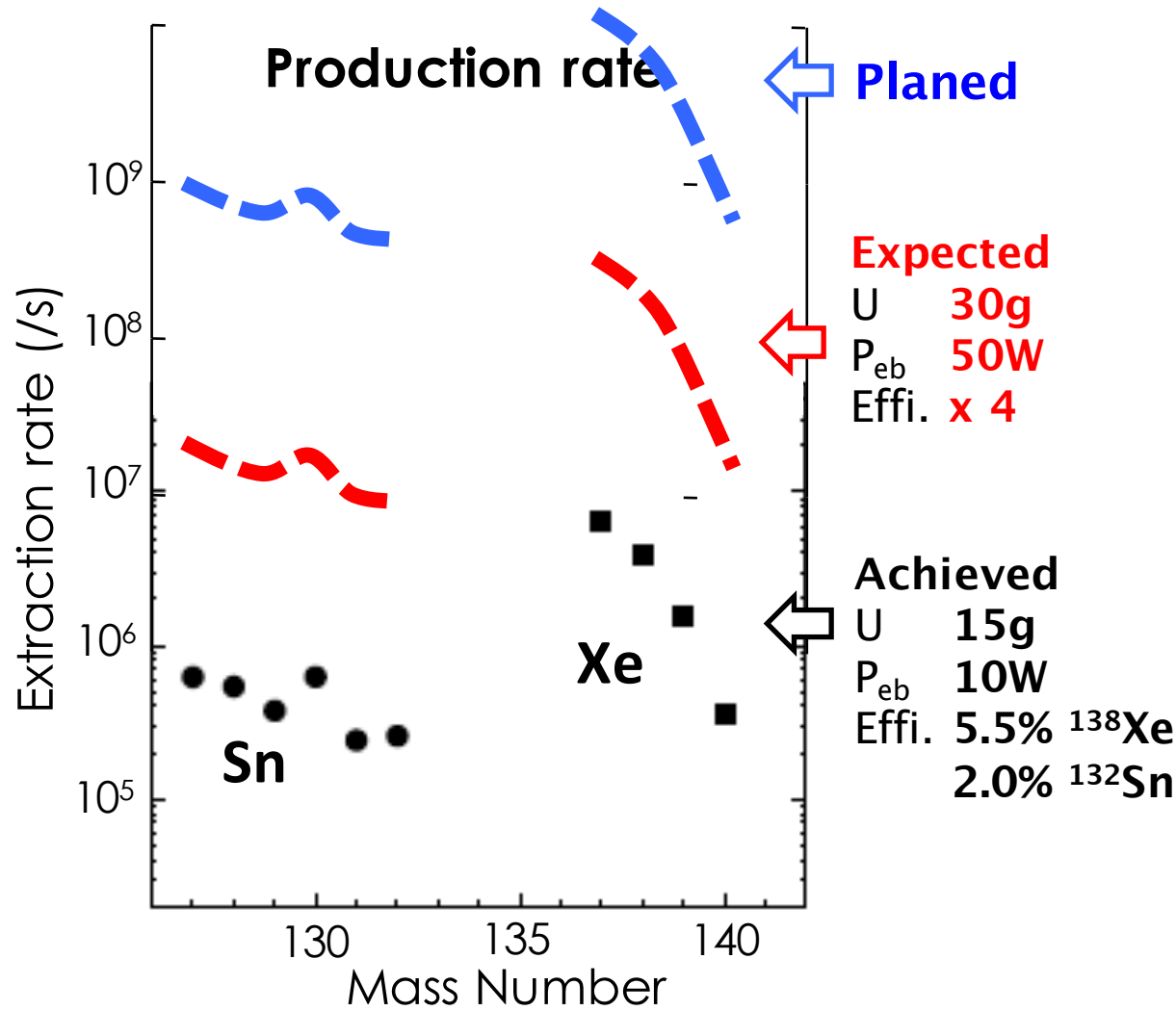


~2000°C

FEBIAD
ion source

Electron beam
from RTM

RI ion beam from ERIS



Improvements are currently going on

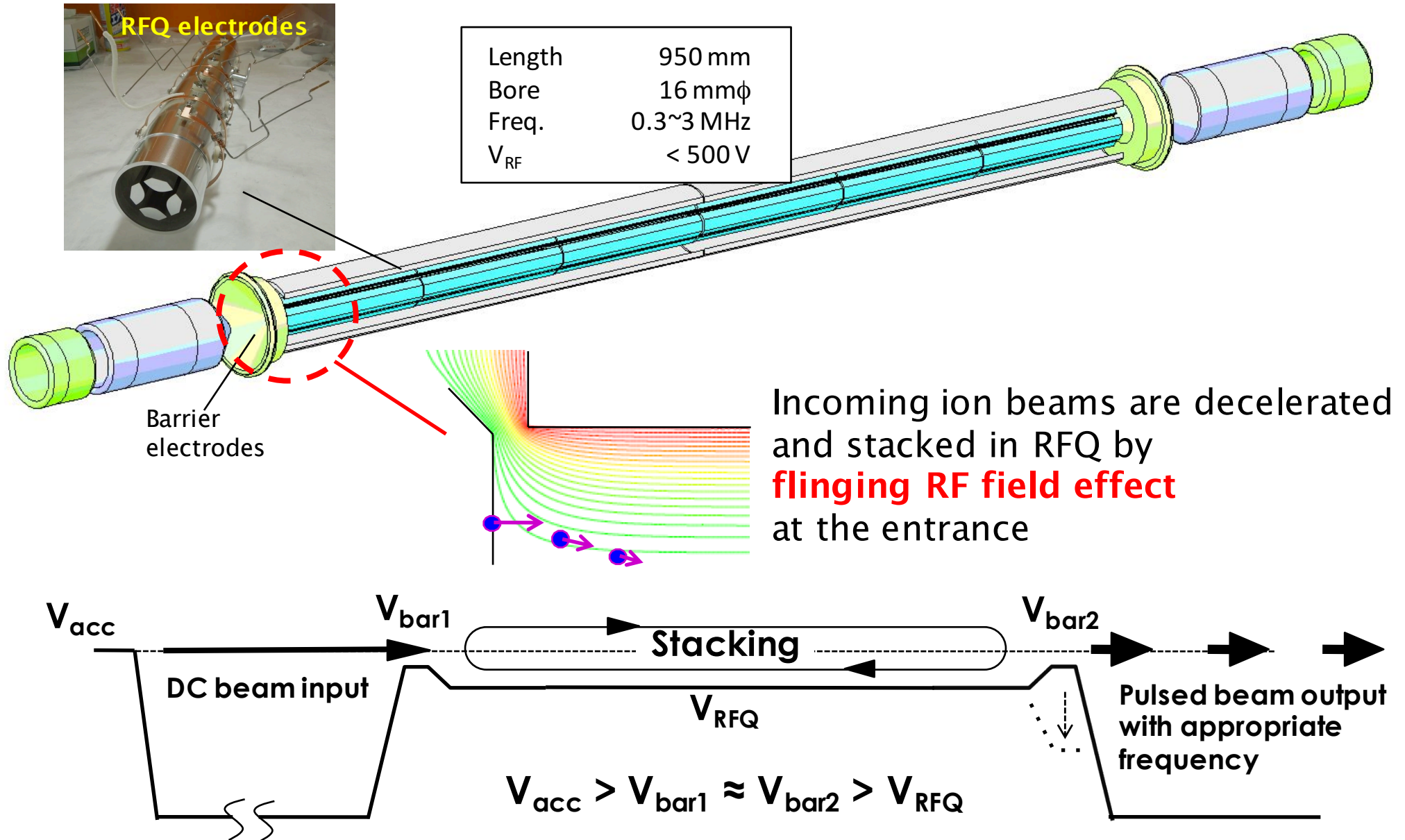
1. Increase the amount of U
2. Extraction efficiency improvement
3. Upgrade e-beam power

First experiment of e-RI scattering

Further upgrade of e-beam power to 2~3kW

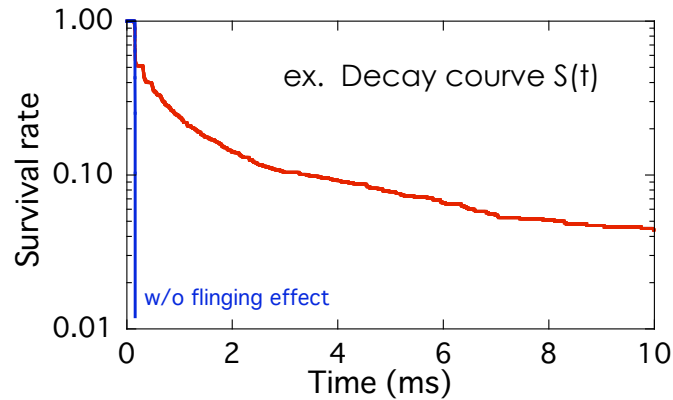
Buncher Device for Ion Injection to SCRIT

Buncher based on RFQ linear trap converts 1-s DC beam into 500 μ s pulsed beam



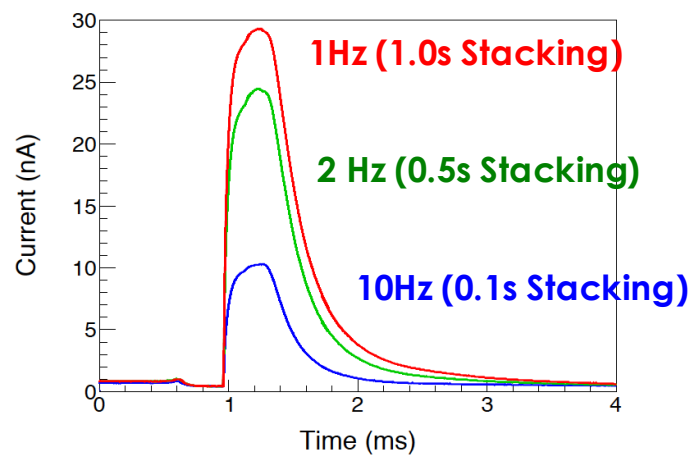
Ion stacking using flinging field and conversion efficiency

Stacked ions slowly decay

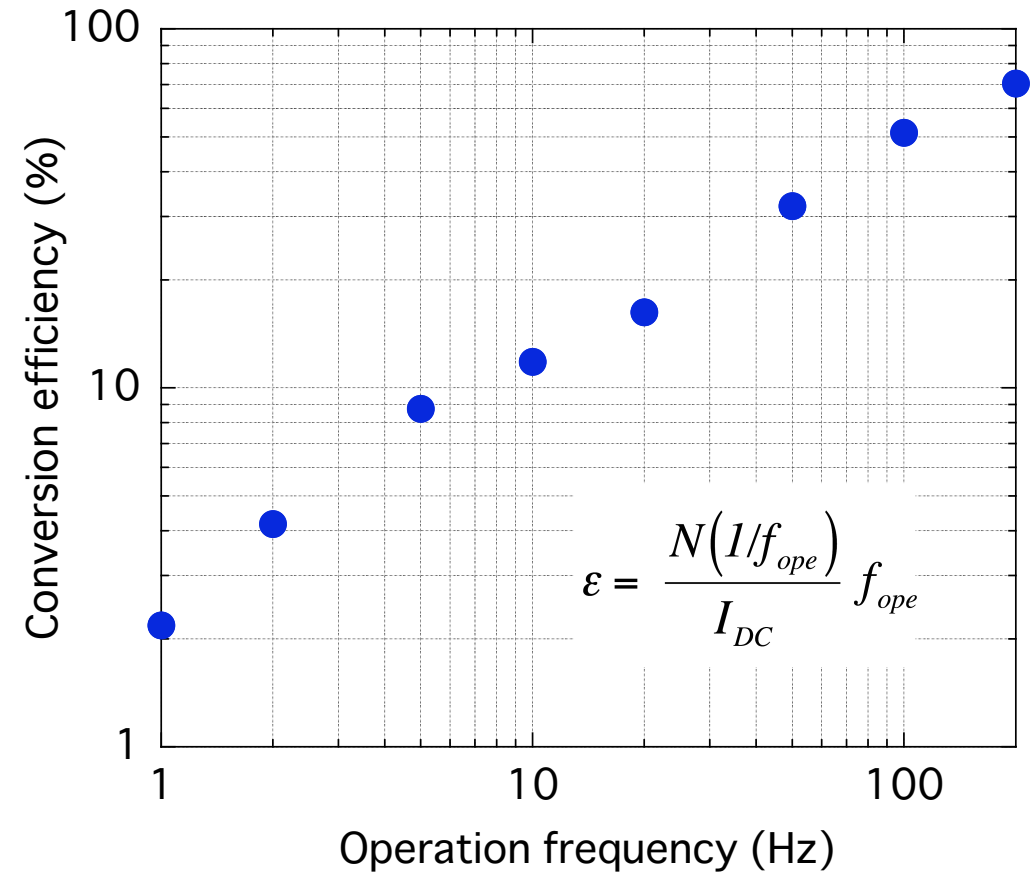


Number of stacked ions $N(t)$:

$$N(t) = I_{DC} \int_0^t S(t - t') dt'$$

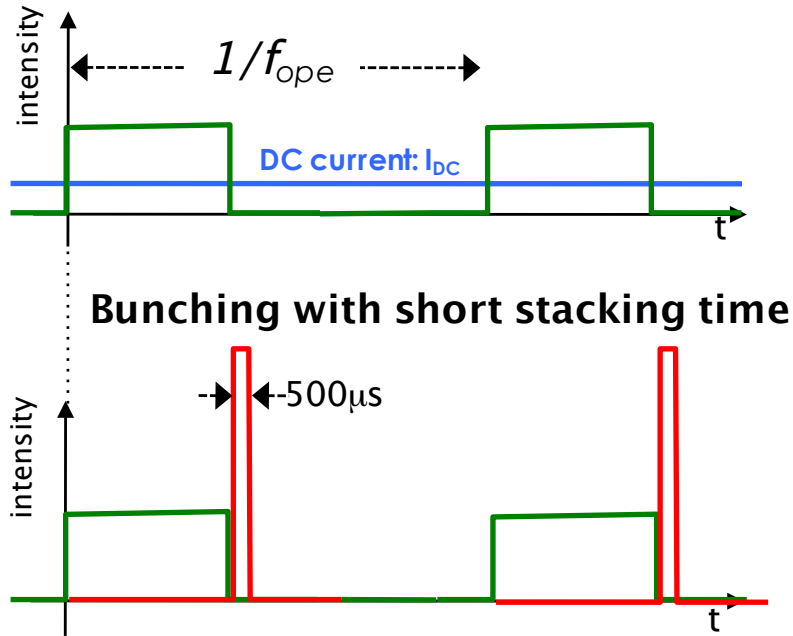


DC-Pulse conversion efficiency

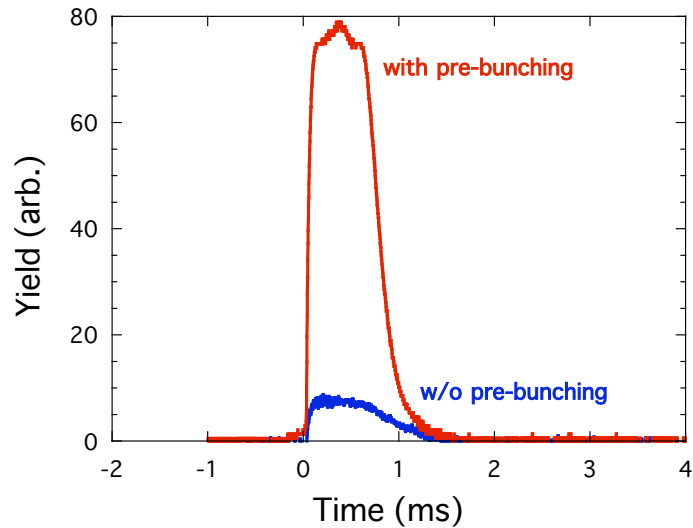


More efficient conversion using two-step bunching

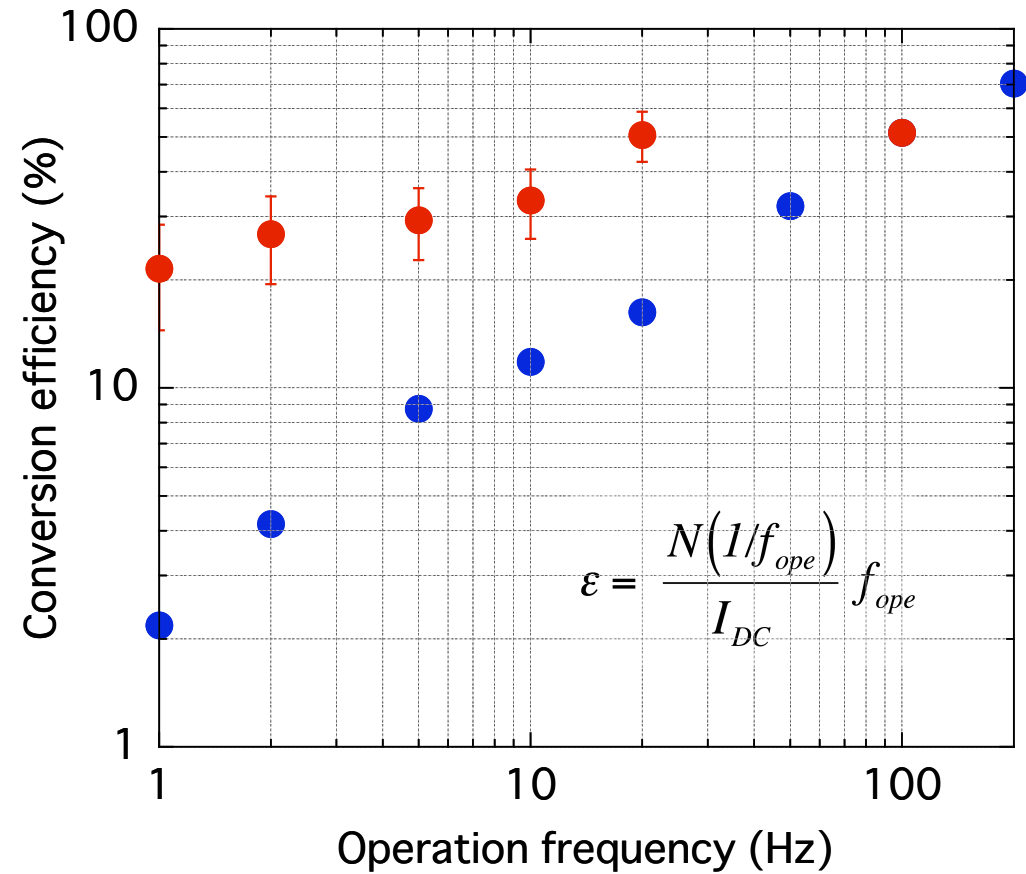
Pre-bunching using grid action at ion source



Bunching with short stacking time



DC-Pulse conversion efficiency



Summary

1. The SCRIT facility has been constructed and is now in test experiment phase.
2. Achieved luminosity is $\sim 3 \times 10^{27} / (\text{cm}^2 \text{s})$.
3. Upper limit of achievable luminosity in our SCRIT system is $\sim 10^{29} / (\text{cm}^2 \text{s})$.
4. Electron-beam-instability suppression is the most important issue to get higher luminosity.
5. It is essential to understand relationship between electron-beam properties and ion-trapping properties.
6. We will be able to move to the experiments for unstable isotopes as soon as possible.

Thank you for your attention